As an inventor named below or on any attached continuation page, I hereby declare that:

My residence, post office address and citizenship are as stated next to my name.

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled DIFFERENTIAL PRESSURE APPLICATION APPARATUS FOR USE IN POLISHING LAYERS OF SEMICONDUCTOR DEVICE STRUCTURES AND METHODS, the specification of which (check

nic).		• • • •	
☐ is attached hereto. ■ was filed on July 25, 2001 as United Stat	es application serial no. 09/912,982.	1.1l. DOT Assisle 10 on	
□ was filed on as PCT internal	ional application no and was ame	nded under PCT Article 19 on	
I hereby state that I have reviewed and under eferred to above.	rstand the contents of the above-identified speci	fication, including the claims, as amen	led by any amendment
		known to me to be material to the nate	ntability of the subject
natter claimed in this application, as "materiali	 Patent and Trademark Office all information ty is defined in Title 37, Code of Federal Regulation 	mattons & 1.50.	
ertificate or § 365(a) of any PCT international	er Title 35, United States Code, § 119(a)-(d) or application(s) designating at least one country could below and on any attached continuation pages east one country other than the United States of	e any foreign application for patent or	inventor's certificate or an
o :	·	·	22.0
Prior foreign/PCT application(s):			Priority Claimed
	(country)	(day/month/year filed)	Yes No
(number)	(country)	(
(number)	(country)	(day/month/year filed)	Yes No
designating the United States of America listed application is not disclosed in any such prior ap duty to disclose to the U.S. Patent and Tradema Regulations § 1.56 which became available between	ween the filing date of such prior application an		ng date of this application:
(application serial no.)	(filing date)		
(application serial no.)	(filing date)	(status - pending, patented or	abandoned)
	The second secon	isional application(s) listed below	v•
I hereby claim the benefit under Title 35, U	nited States Code, § 119(e) of any United State	s provisional application(s) listed below	••
(provisional application no.)	(filing date)		
I hereby appoint the following Registered Pr	actitioners to prosecute this application and to	transact all business in the Patent and I	rademark Office connected
•	William S. Britt, Reg. No. 20,969	Laurence B. Bond, Reg. No. 30,	,549
David V. Trask, Reg. No. 22,012 Joseph A. Walkowski, Reg. No. 28,765 Allen C. Turner, Reg. No. 33,041 Brick G. Power, Reg. No. 38,581 Krista Weber Powell, Reg. No. 47,867 Shawn G. Hansen, Reg. No. 42,627 Katherine A. Hamer, Reg. No. 47,628	James R. Duzan, Reg. No. 28,393 Edgar R. Cataxinos, Reg. No. 39,931 Paul C. Oestreich, Reg. No. 44,983 Jarett K. Abramson, Reg. No. 47,376 Bretton L. Crockett, Reg. No. 44,632 Michael L. Lynch, Reg. No. 30,871	H. Dickson Burton, Reg. No. 1 Kent S. Burningham, Reg. No. 3 Devin R. Jensen, Reg. No. 44,8 David L. Stott, Reg. No. 43,937 Bradley B. Jensen, Reg. No. 46, Charles B. Brantley II, Reg. No.	P-48,396 30,453 05 , ,801
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	rein of my own knowledge are true and that all	statements made on information and b nd the like so made are punishable by t ments may jeopardize the validity of the	elief are believed to be true fine or imprisonment, or ne application or any patent

Citizenship: U.S.A. Post Office Address: 1435 Jenna Lane, Cedar Park, TX 78613

Full name of sole inventor Inventor's signature Residence: Cedar Park, Texas